

#### **Features**

- Low current 0.5mA
- Superior CTR-2000%
- CTR guaranteed 0–70 °C

#### **Applications**

- Digital logic ground isolation
- Telephone ring detector
- EIA-RS-232C line receiver
- High common mode noise line receiver
- $\mu$  P bus isolation
- Current loop receiver

#### **Description**

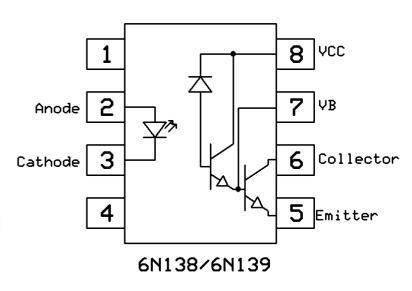
The 6N138 & 6N139 optocouplers consist of an AlGaAs LED optically coupled to a high gain split darlington photodetector.

The combination of a very low input current of 0.5mA and a high current transfer ratio of 2000% makes this family particularly useful for input interface to MOS, CMOS, LSTTL and EIA RS232C, while output compatibility is ensured to CMOS as well as high fan-out TTL requirements.

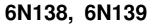
The devices are packaged in an 8-pin DIP package and also available in gullwing (400mil) spacing and surface mount lead forming option.

#### **Package Outline**

#### **Schematic**



Note: Different lead forming options available. See package dimension.





### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes	
Viso	Isolation voltage	5000	V <sub>RMS</sub>		
Topr	Operating temperature		-55 ~ +100	°C	
Тѕтс	Storage temperature		-55 ~ +125	°C	
Tsol	Soldering temperature		260	°C	
Emitter				·	
l <sub>F</sub>	Forward current		25	mA	
I <sub>FP</sub>	Peak forward current (50% duty, 1ms P.W)		50	mA	
I <sub>F(TRANS)</sub>	Peak transient current (≤1µs P.W,300pps)	1	Α		
V <sub>R</sub>	Reverse voltage	5	V		
P <sub>D</sub>	Power dissipation	40	mW		
Detector	•				
P <sub>D</sub>	Power dissipation	100	mW		
V <sub>EBR</sub>	Emitter-Base reverse voltage		0.5	V	
lo	Output Current	60	mA		
V	Outro de volto do	6N138	-0.5 to 7	V	
Vo	Output voltage 6N1	6N139	-0.5 to 18	V	
V	Cumply voltage	6N138	-0.5 to 7	V	
Vcc	Supply voltage	6N139	-0.5 to 18	V	



#### **Electrical Characteristics** $T_A = 0 - 70 \, \text{C}$ , $V_{CC} = 4.5 \text{V}$ (unless otherwise specified).

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I <sub>F</sub> = 16mA	-	1.45	1.6	٧	
IR	Reverse Current	V <sub>R</sub> = 5V	-	-	5	μΑ	
$\Delta V_F/\Delta T_A$	Temperature coefficient of forward voltage	I <sub>F</sub> =16mA	-	-1.8	-	mV/℃	

#### **Detector Characteristics**

Symbol	Parameter	s	Test Conditions	Min	Тур	Max	Units	Notes
lau	Logic High Output	6N139	L 0m/ \/- \/ 10\/	-	0.008	80		
IOH	I <sub>OH</sub> Current I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =18V,	-	-	200	μΑ			
Iccl	Logic Low Supply Current		I <sub>F</sub> =1.6mA, V <sub>O</sub> =Open, V <sub>CC</sub> =18V	-	0.5	1.4	mA	
Іссн	Logic High Supply Current		I <sub>F</sub> =0mA, V <sub>O</sub> =Open, V <sub>CC</sub> =18V	-	0.04	8	μΑ	

#### **Transfer Characteristics**

Symbol	Parameters		Test Conditions	Min	Тур	Max	Units	Notes
	O T	6N139	I <sub>F</sub> =0.5mA, V <sub>O</sub> =0.4V,	400	2500	-		
CTR	Current Transfer	6N138	I <sub>F</sub> =1.6mA, V <sub>O</sub> =0.5V,	300	2000	-	%	
	Ratio	6N139		500	2000	-		
	Logic Low Output Voltage	CNIAGO	I <sub>F</sub> = 0.5mA, I <sub>O</sub> = 2mA	-	0.04	0.4		
			I <sub>F</sub> = 1.6mA, I <sub>O</sub> = 8mA	-	0.08	0.4		
$V_{OL}$		6N139	I <sub>F</sub> = 5mA, I <sub>O</sub> = 15mA	-	0.11	0.4	V	
			I <sub>F</sub> = 12mA, I <sub>O</sub> = 24mA	-	0.16	0.4		
		6N138	I <sub>F</sub> = 1.6mA, I <sub>O</sub> = 4.8mA	-	0.05	0.4		



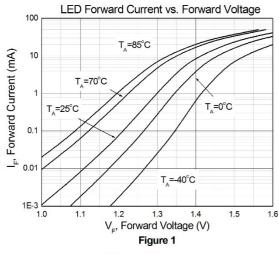
### **Electrical Characteristics** $T_A = 0 - 70 \, \text{C}$ , $V_{CC} = 5V$ (unless otherwise specified).

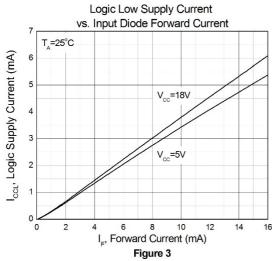
#### **Switching Characteristics**

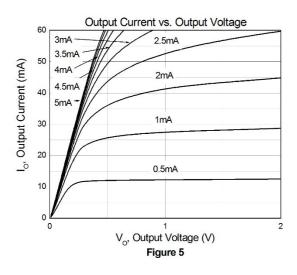
Out of the property of the pro									
Symbol	Paramete	ers	Test Conditions		Min	Тур	Max	Units	Notes
		6N139	I <sub>F</sub> = 0.5mA,		-	-	30	μs	
			R <sub>L</sub> = 4.7k	T <sub>A</sub> = 25 <sup>0</sup> C	-	4.8	25		
Т	High to Low		I <sub>F</sub> = 12mA,		ı	-	2		
$T_PHL$	Propagation Delay		R <sub>L</sub> = 250	T <sub>A</sub> = 25 <sup>0</sup> C	ı	0.2	1		
		6N1120	I <sub>F</sub> = 1.6mA,		1	-	15		
		6N138	R <sub>L</sub> = 2.2k	T <sub>A</sub> = 25 <sup>0</sup> C	-	1.35	10		
		6N139	I <sub>F</sub> = 0.5mA,		-	-	90	_ - - μs	
			R <sub>L</sub> = 4.7k	T <sub>A</sub> = 25 <sup>0</sup> C	-	15	60		
_	Low to High		I <sub>F</sub> = 12mA,		-	-	10		
$T_PLH$	Propagation Delay		R <sub>L</sub> = 250	T <sub>A</sub> = 25 <sup>0</sup> C	-	1.6	7		
		6N138	I <sub>F</sub> = 1.6mA,		-	-	50		
		011130	R <sub>L</sub> = 2.2k	T <sub>A</sub> = 25 <sup>0</sup> C	-	7.6	35		
СМн	Common Mode Transient		I <sub>F</sub> = 0mA,  VCM  = 10V <sub>P-P</sub> ,		1,000				
CIVIH	Immunity at Logic High		T <sub>A</sub> = 25 °C, R <sub>L</sub> = 2.2	2kΩ	1,000	-		V/μs	
CM∟	Common Mode Transient		I <sub>F</sub> = 1.6mA,  VCM	= 10V <sub>P-P</sub> ,	1,000	20		ν/μδ	
CIVIL	Immunity at Logic Lo	W	$T_A = 25 ^{\circ}\text{C}, R_L = 2.2$	2kΩ	1,000	0 -	-		

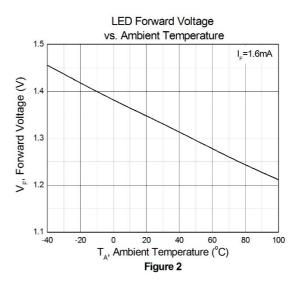


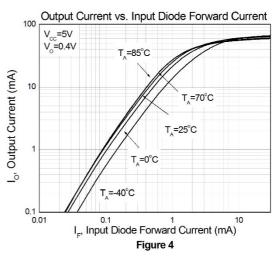
#### **Typical Characteristic Curves**

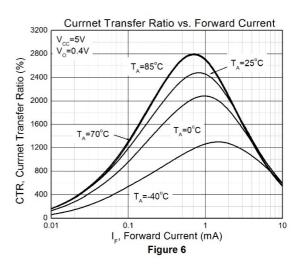




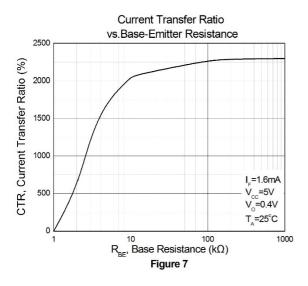


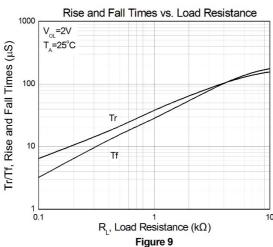


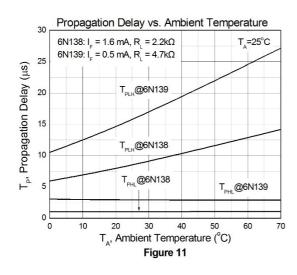


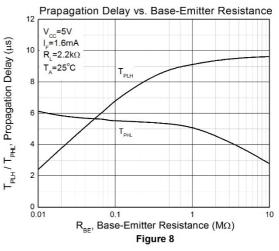


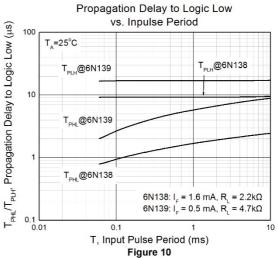


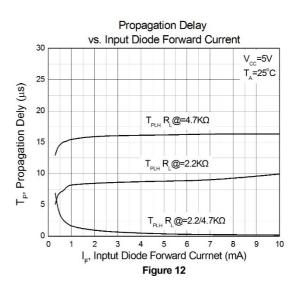






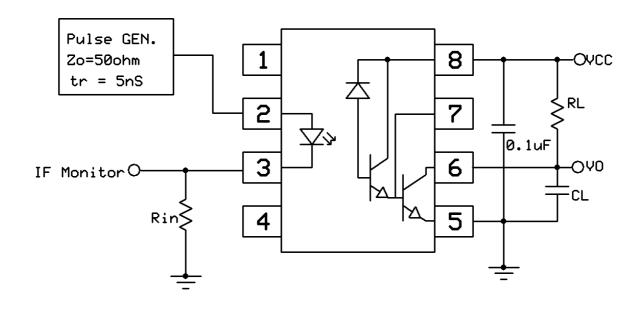


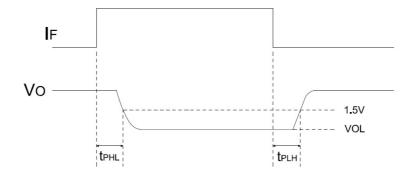






#### **Test Circuits**

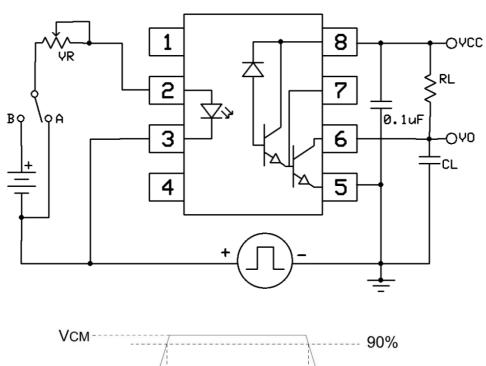


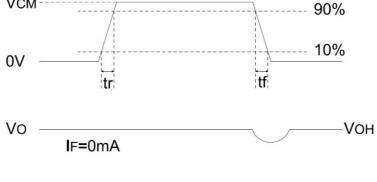


Switching Time Test Circuit



#### **Test Circuits**





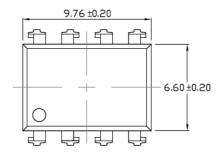


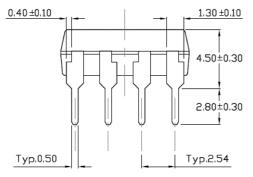
CMR Test Circuit

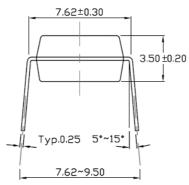


#### Package Dimension Dimensions in mm unless otherwise stated

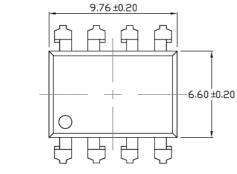
#### Standard DIP - Through Hole

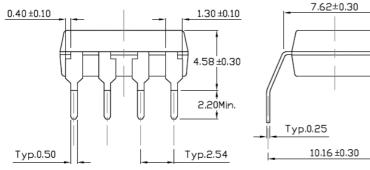






#### **Gullwing (400mil) Lead Forming – Through Hole (M Type)**

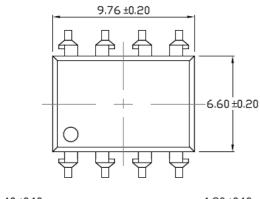


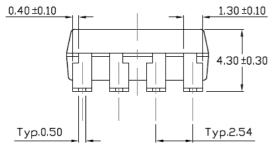


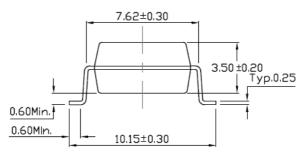
3.50 ±0.20



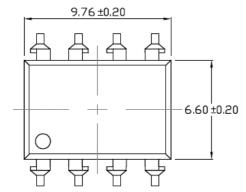
### **Surface Mount Lead Forming (S Type)**

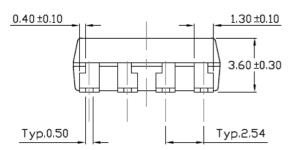


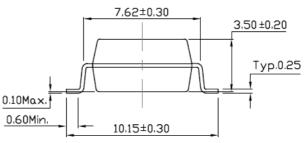




#### **Surface Mount (Low Profile) Lead Forming (SL Type)**

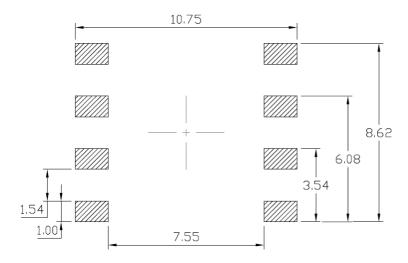




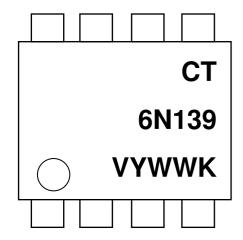




#### Recommended Solder Mask Dimensions in mm unless otherwise stated



### **Device Marking**



CT : Denotes "CT Micro"6N139 : Product NumberV : VDE Option

Y : Fiscal Year WW : Work Week

K : Production Code



### **Ordering Information**

6N13X(V)(Y)(Z)

X = Part No. (8 or 9)

V = VDE Option (V or None)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1, T2 or none)

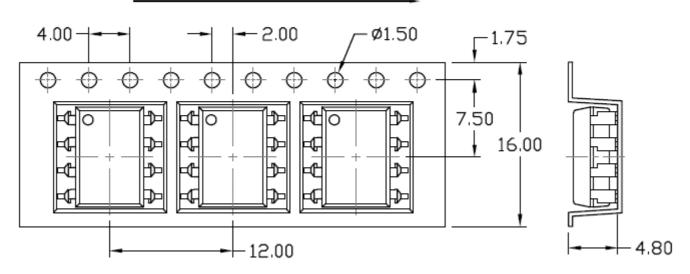
Option	Description	Quantity
None	Standard 8 Pin Dip	40 Units/Tube
М	Gullwing (400mil) Lead Forming	40 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming- With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming- With Option 2 Taping	1000 Units/Reel



#### Carrier Tape Specifications Dimensions in mm unless otherwise stated

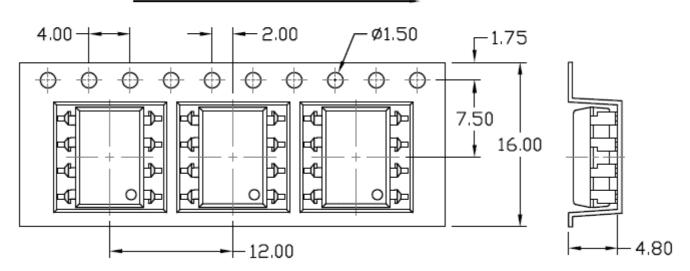
Option S(T1) & SL(T1)

# Input Direction



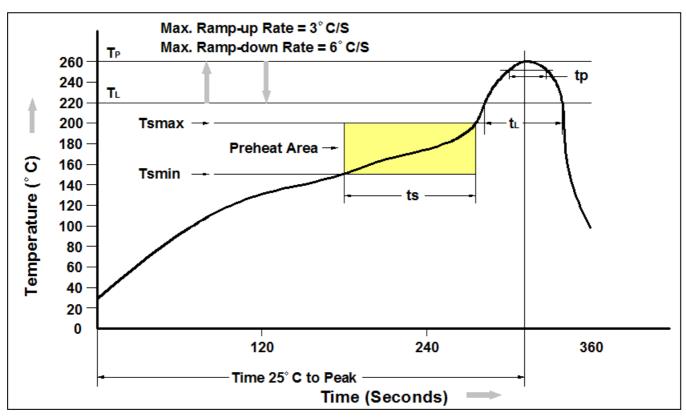
#### Option S(T2) & SL(T2)

# Input Direction

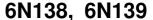




#### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150℃
Temperature Max. (Tsmax)	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (TL)	217℃
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260℃ +0℃ / -5℃
Time (t <sub>P</sub> ) within 5 °C of 260 °C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6 ℃/second max
Time 25 ℃ to Peak Temperature	8 minutes max.





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